

AC Thyristor Triac power switch

Rev.02 - 25 April 2019

Product data sheet

1. General description

AC Thyristor Triac power switch in a TO263 (D2PAK) surface mountable plastic package with self-protective clamping capabilities against low and high energy transients.

2. Features and benefits

- · Clamping structure ensuring safe high over-voltage withstand capability
- High minimum IGT for guaranteed immunity to gate noise
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Planar passivated for voltage ruggedness and reliability
- Protective self turn-on capability for high energy transients
- Safe clamping capability for low energy over-voltage transients
- Less sensitive gate for high noise immunity
- Surface mountable package
- Triggering in three quadrants only
- Very high immunity to false turn-on by dV/dt

3. Applications

- AC fan, pump and compressor controls
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- · Reversing induction motor controls

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 105 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	-	8	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u>	-	-	80	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	-	88	А
T _j	junction temperature		-	-	125	°C
V_{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; Fig. <u>6</u>	-	-	2	kV

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics	·			-	-	
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 100 \text{ mA}; \text{ LD+ G+};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 8}$		5	-	30	mA
		V_{D} = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; Fig. 8		5	-	30	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 100 \text{ mA}; \text{ LD- G-};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 8}$		5	-	30	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>		-	-	35	mA
V _T	on-state voltage	I _T = 10 A; T _j = 25 °C; <u>Fig. 11</u>		-	1.3	1.5	V
V _{CL}	clamping voltage	ping voltage $I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j = 25 \text{ °C}$		850	-	-	V
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit		2000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 8 \text{ A};$ $dV_{com}/dt = 1 \text{ V}/\mu\text{s}; \text{ (snubberless condition); gate open circuit}$		8	-	-	A/ms

5. Pinning information

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	СМ	common		
2	LD	load		
3	G	gate		G
mb	LD	mounting base; load		 CM 003aaf296

6. Ordering information

Table 3. Ordering information						
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
ACTT8B-800C0	TO263	ACTT8B-800C0J	Reel	800	TO263E	26-May-2017

7. Marking

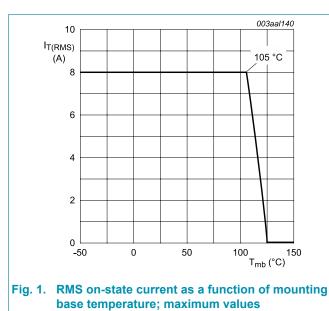
Table 4. Marking codes				
Type number	Marking Code			
ACTT8B-800C0	ACTT8B-800C0			

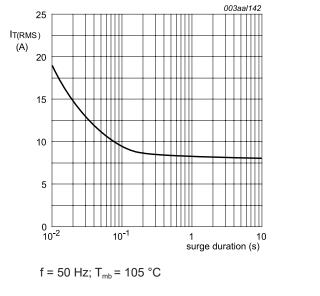
8. Limiting values

Table 5. Limiting values

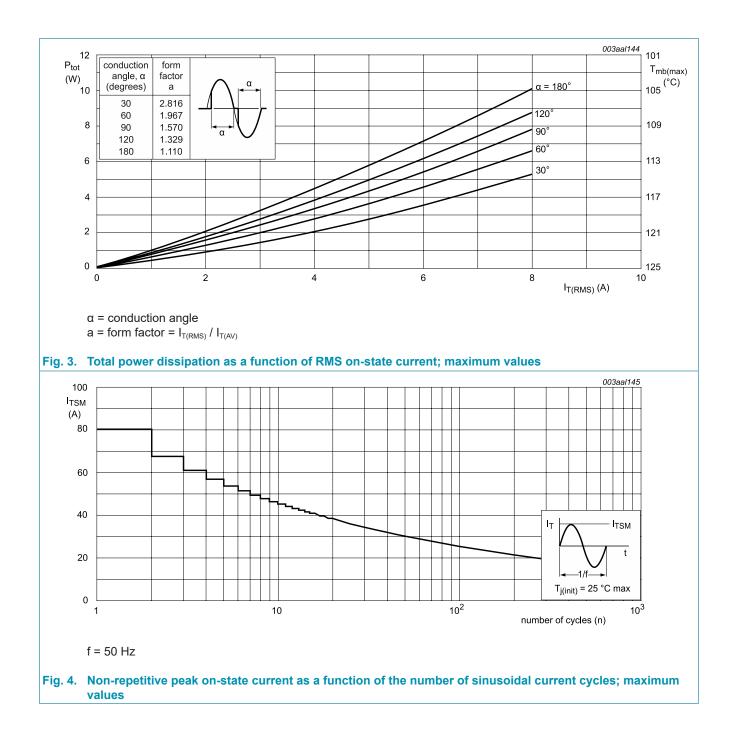
In accordance with the Absolute Maximum Rating System (IEC 60134).

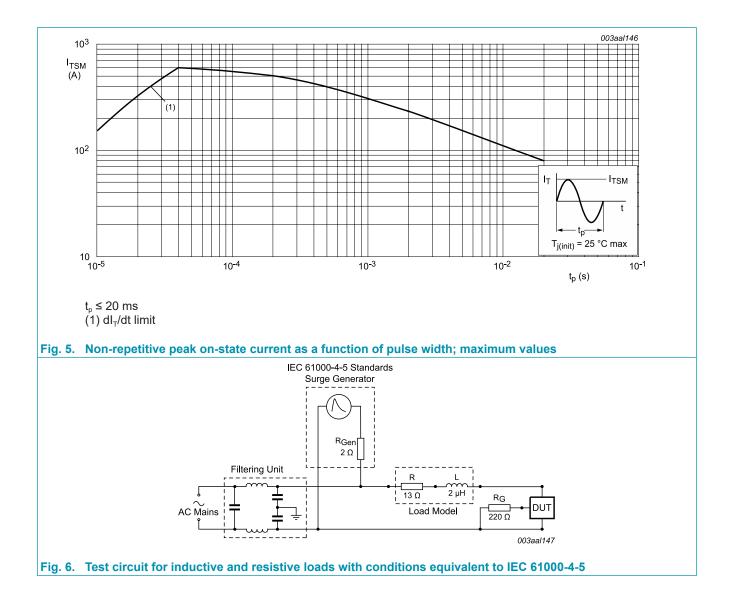
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	800	V
$\mathbf{I}_{\mathrm{T}(\mathrm{RMS})}$	RMS on-state current	full sine wave; T _{mb} ≤ 105 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	8	A
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig 4; Fig 5	-	80	А
		full sine wave; $T_{j(init)}$ = 25 °C; $t_{\rm p}$ = 16.7 ms	-	88	А
l ² t	l ² t for fusing	t _p = 10 ms; sine-wave pulse	-	32	A ² s
dl _T /dt	rate of rise of on-state current	I _G = 60 mA	-	100	A/µs
I _{GM}	peak gate current	t _p = 20 μs	-	2	А
P_{GM}	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	125	°C
V _{pp}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; <u>Fig 6</u>	-	2	kV





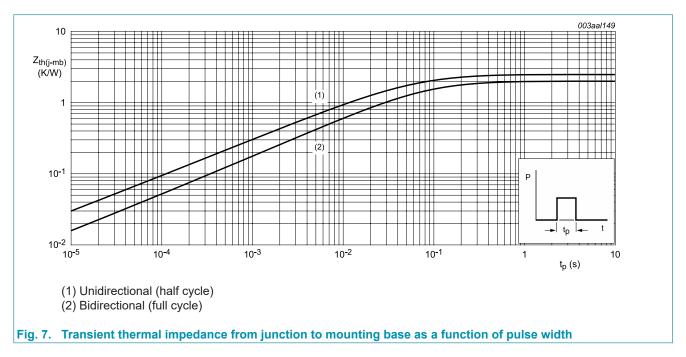






9. Thermal characteristics

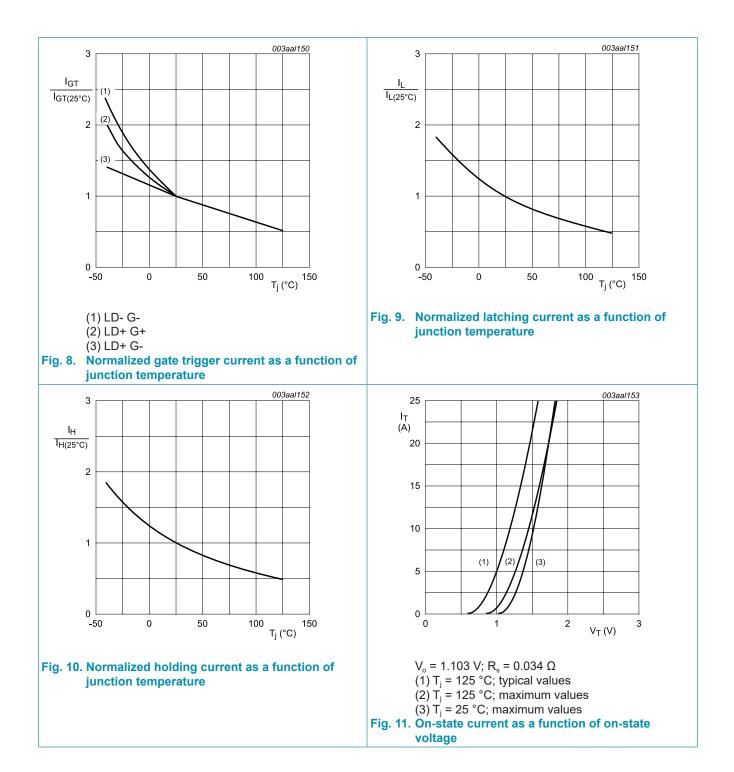
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)} thermal resistance		full cycle; <u>Fig. 7</u>	-	-	2	K/W
	from junction to mounting base	half cycle; <u>Fig. 7</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air; printed circuit board (FR4) mounted	-	55	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 100 mA; LD+ G+; T _j = 25 °C; <u>Fig. 8</u>	5	-	30	mA
		$V_{\rm D}$ = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; Fig. 8	5	-	30	mA
		$V_{\rm D}$ = 12 V; I _T = 100 mA; LD- G-; T _j = 25 °C; Fig. 8	5	-	30	mA
IL	latching current	$V_{D} = 12 \text{ V}; \text{ I}_{G} = 100 \text{ mA}; \text{ LD+ G+};$ T _j = 25 °C; Fig. 9	-	-	50	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{G} = 100 \text{ mA}; \text{ LD+ G-};$ T _j = 25 °C; Fig. 9	-	-	70	mA
		V_{D} = 12 V; I _G = 100 mA; LD- G-; T _j = 25 °C; Fig. 9	-	-	50	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>	-	-	35	mA
V _T	on-state voltage	I _T = 10 A; T _j = 25 °C; <u>Fig. 11</u>	-	1.3	1.5	V
V_{GT}	gate trigger voltage	V _D = 12V; I _T = 100 mA;T _j = 25 °C; Fig. 12	-	0.8	1	V
		V _D = 400V; I _T = 100 mA;T _j = 125 °C; Fig. 12	0.2	0.45	-	V
I _D	off-state current	V _D = 800 V; T _j = 25 °C	-	-	10	μA
		V _D = 800 V; T _j = 125 °C	-	-	0.5	mA
V _{CL}	clamping voltage	$I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j = 25 \text{ °C}$	850	-	-	V
Dynamic	characteristics	· · ·		,		
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	2000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 8 \text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; (snubberless condition); gate open circuit$	8	-	-	A/ms

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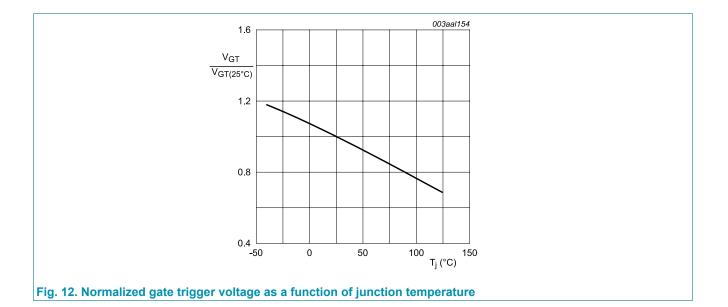


ACTT8B-800C0
Product data sheet

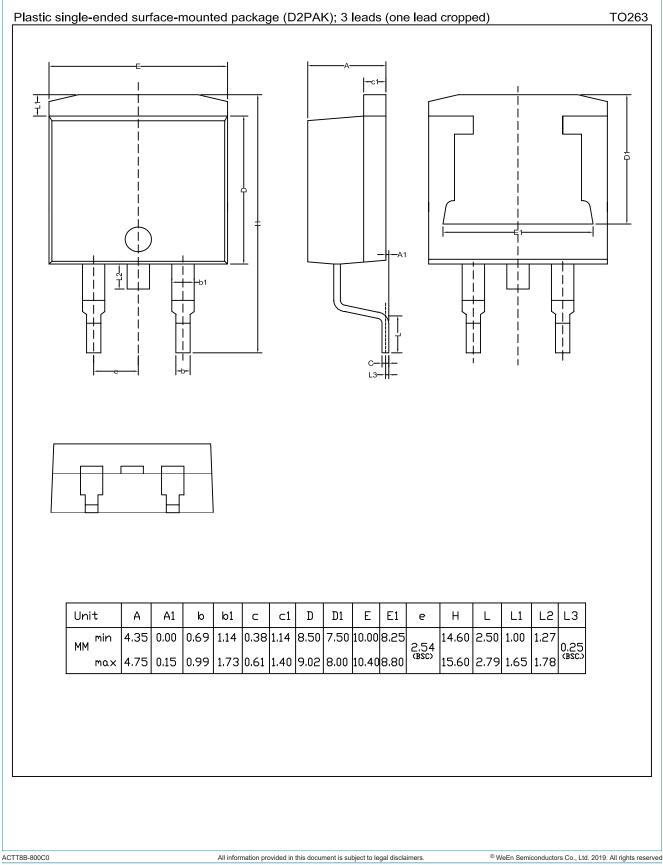
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ACTT8B-800C0

AC Thyristor Triac power switch



11. Package outline



AC Thyristor Triac power switch

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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